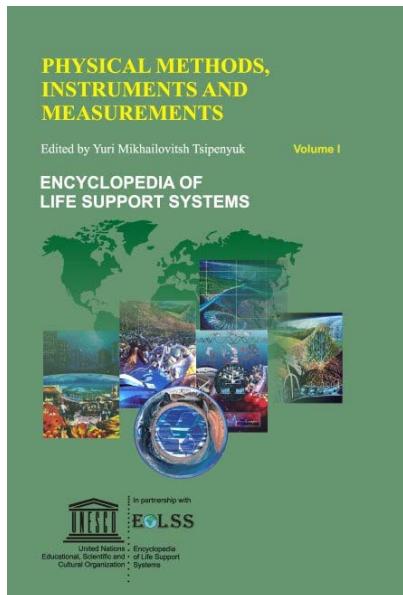


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## PHYSICAL METHODS, INSTRUMENTS AND MEASUREMENTS



### Physical Methods, Instruments and Measurements - Volume 1

No. of Pages: 420

ISBN: 978-1-905839-54-4 (eBook)

ISBN: 978-1-84826-954-5 (Print Volume)

### Physical Methods, Instruments and Measurements - Volume 2

No. of Pages: 420

ISBN: 978-1-905839-55-1 (eBook)

ISBN: 978-1-84826-955-2 (Print Volume)

### Physical Methods, Instruments and Measurements - Volume 3

No. of Pages: 420

ISBN: 978-1-905839-56-8 (eBook)

ISBN: 978-1-84826-956-9 (Print Volume)

### Physical Methods, Instruments and Measurements - Volume 4

No. of Pages: 420

ISBN: 978-1-905839-57-5 (eBook)

ISBN: 978-1-84826-957-6 (Print Volume)

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